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# 256-Channel Analog Front-End for Flat-Panel Digital X-Ray Detector

Check for Samples: AFE0256

## **FEATURES**

- 256 Channels
- On-Chip, 14-Bit ADC
- High Performance:
  - Noise: 758 electronRMS (eRMS) with 28-pF Sensor Capacitor in 1.2-pC Range
  - Integral Nonlinearity: ±1.25 LSB with Internal 14-Bit ADC
  - Minimum Scan Time:
    - Normal Mode: 37.9 µs, Internal ADC
    - 2x Binning Mode: 26 μs, Internal ADC
- Integration:
  - Eight Selectable, Full-Scale Ranges:
    - 0.15 pC (min) to 9.6 pC (max)
  - Built-In Correlated Double Sampler
  - 2x Binning for Faster Throughput:
    - Averages Charge of Two Adjacent Channels
  - Pipelined Integration and Read:
    - Allows Data Read During Integration
- Flexibility:
  - Electron and Hole Integration
  - Analog Output Provided for External High-Resolution ADC
- Low Power:
  - 2.9 mW per Channel with ADC
  - 2.3 mW per Channel without ADC
  - 0.1 mW per Channel in Nap Mode
  - Total Power-Down Feature
- 22-mm x 5-mm Gold-Bump Die Suitable for Tape Carrier Package (TCP) or Chip-on-Film (COF)

## **APPLICATIONS**

Flat-Panel X-Ray Detectors

#### **DESCRIPTION**

The AFE0256 is a 256-channel analog front-end (AFE) designed to suit the requirements of flat-panel detector (FPD)-based digital x-ray systems. The device includes 256 integrators, a programmable gain amplifier (PGA) for full-scale charge level selection, a correlated double sampler (CDS) with dual banking, 256:4 analog multiplexers, and four differential output drivers.

The device also features four 14-bit successive-approximation register (SAR) analog-to-digital converters (ADCs) on board. Serial data from the ADCs are available in SPI™ format.

Hardware-selectable integration polarity allows positive or negative charge integration and provides more flexibility in system design. The Nap feature enables substantial power saving that is especially useful in battery-powered systems.

The AFE0256 is available as a 22-mm × 5-mm singulated format with known good gold-bump dies.

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Tray, Top Side

Single Gold-Bump Unit, Back Side

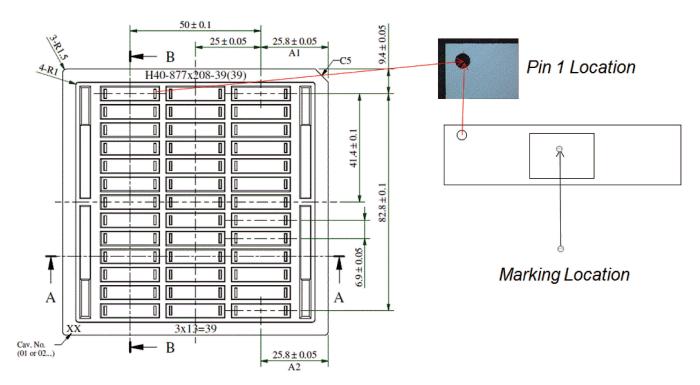


Figure 1. Tray Information

Submit Documentation Feedback

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# **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Original (December 2012) to Revision A |                              |   |  |  |  |  |
|---|------------------------------|---|--|--|--|--|
| •   | Changed last Features bullet |   |  |  |  |  |
| •   | Updated Figure 1             | 2 |  |  |  |  |



## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| AFE0256GBTD      | ACTIVE |              |                    | 0    | 39             | RoHS & Green | AU                            | Level-1-260C-UNLIM | 0 to 85      | AFE0256                 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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